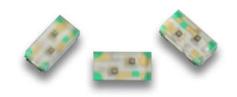


APHB1608SYKSURKC

1.6 x 0.8 x 0.5 mm Bi-Color Surface Mount LED



DESCRIPTIONS

- The Super Bright Yellow device is made with AlGaInP (on GaAs substrate) light emitting diode chip
- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- Electrostatic discharge and power surge could damage the LEDs
- . It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

FEATURES

- 1.6 x 0.8 mm SMD LED, 0.5 mm thickness
- · Compatible with reflow soldering
- Available in various color combination
- · Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- Tinned pads for improved solderability
- RoHS compliant

APPLICATIONS

- Backlight
- · Status indicator
- · Home and smart appliances
- · Wearable and portable devices
- Healthcare applications

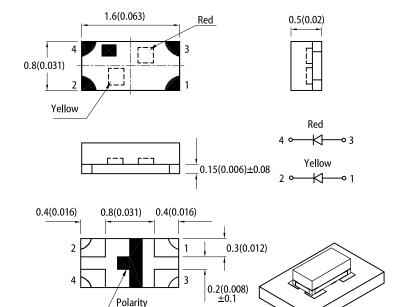
SELECTION GUIDE

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices



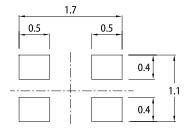
PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

Mark

(units: mm; tolerance: \pm 0.1)



- 1. All dimensions are in millimeters (inches)
- Tolerance is ±0.15(0.006") unless otherwise noted.
 The specifications, characteristics and technical data described in the datasheet are subject to
- change without prior notice.

 The device has a single mounting surface. The device must be mounted according to the specifications.

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 20mA [2]		Viewing Angle [1]
			Min.	Тур.	201/2
APHB1608SYKSURKC	Super Bright Yellow (AlGaInP)	· Water Clear	80	150	130°
			*80	*150	
	■ Hyper Red (AlGaInP)		120	250	
			*40	*90	

Notes:

1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity / luminous flux: +/-15%.

* Luminous intensity value is traceable to CIE127-2007 standards.





ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Paramatan.	Symbol		Value		
Parameter		Emitting Color	Тур.	Max.	Unit
Wavelength at Peak Emission I _F = 20mA	λ_{peak}	Super Bright Yellow Hyper Red	590 645	-	nm
Dominant Wavelength I _F = 20mA	λ _{dom} ^[1]	Super Bright Yellow Hyper Red	590 630	-	nm
Spectral Bandwidth at 50% Φ REL MAX $I_F = 20$ mA	Δλ	Super Bright Yellow Hyper Red	20 28	-	nm
Capacitance	С	Super Bright Yellow Hyper Red	20 35	-	pF
Forward Voltage I _F = 20mA	V _F ^[2]	Super Bright Yellow Hyper Red	2 1.95	2.5 2.5	V
Reverse Current (V _R = 5V)	I _R	Super Bright Yellow Hyper Red	-	10 10	μА
Temperature Coefficient of λ_{peak} I _F = 20mA, -10°C \leq T \leq 85°C	С	Super Bright Yellow Hyper Red	0.12 0.14	-	nm/°C
Temperature Coefficient of λ_{dom} I _F = 20mA, -10°C \leq T \leq 85°C	$TC_{\lambda dom}$	Super Bright Yellow Hyper Red	0.07 0.05	-	nm/°C
Temperature Coefficient of V_F I_F = 20mA, -10° C \leq T \leq 85° C	TC _V	Super Bright Yellow Hyper Red	-1.9 -1.9	-	mV/°C

1. The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ± 1 nm.) 2. Forward voltage: ± 0.1 V.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Barrana da re	Symbol	Val		
Parameter		Super Bright Yellow	Hyper Red	Unit
Power Dissipation	P_D	75	75	mW
Reverse Voltage	V _R	5 5		V
Junction Temperature	T _j	115	115	°C
Operating Temperature	T _{op}	-40 to	°C	
Storage Temperature	T _{stg}	-40 to +85		°C
DC Forward Current	I _F	30	30	mA
Peak Forward Current	I _{FM} ^[1]	175	185	mA
Electrostatic Discharge Threshold (HBM)	-	3000	3000	V
Thermal Resistance (Junction / Ambient)	R _{th JA} ^[2]	380	425	°C/W
Thermal Resistance (Junction / Solder point)	R _{th JS} [2]	230	335	°C/W

^{1. 1/10} Duty Cycle, 0.1ms Pulse Width.
2. R_{th JA}, R_{th JS} Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad).
3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

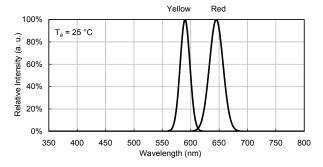


^{2.} Forward voltage: 32.19.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

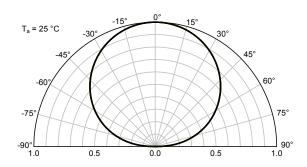


TECHNICAL DATA

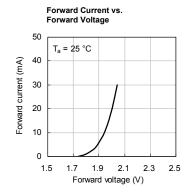
RELATIVE INTENSITY vs. WAVELENGTH

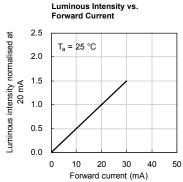


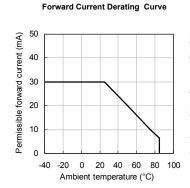
SPATIAL DISTRIBUTION

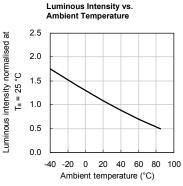


SUPER BRIGHT YELLOW

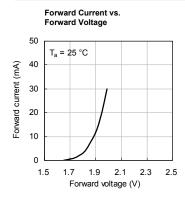


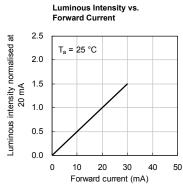


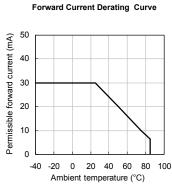


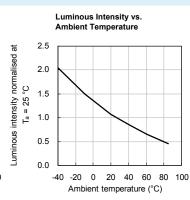


HYPER RED











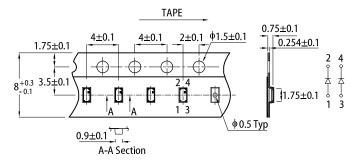
REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

300 above 255°C (°C) 260°C max. 30s max. 10s max. 250 3°C/s max 6°C/s max. 200 150 pre-heating 100 150~200°C above 217°C 60~120s 60~150s 50 50 100 150 200 250 (sec) Time

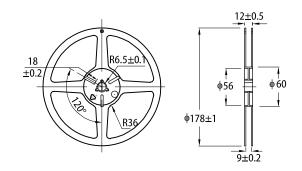
Notes

- Don't cause stress to the LEDs while it is exposed to high temperature.
- The maximum number of reflow soldering passes is 2 times.
 Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

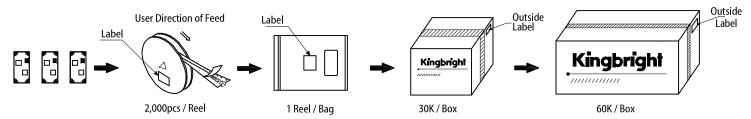
TAPE SPECIFICATIONS (units:mm)



REEL DIMENSION (units: mm)



PACKING & LABEL SPECIFICATIONS





PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.

 The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening
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